

Application No.: 09/966,973
Docket No.: ACT - 162

Art Unit: 2874
Examiner: Jennifer Doan

Amendments to the Specification

Please amend the specification to read as follows.

1. Please amend the abstract as follows.

An optical device package includes a substrate having a top portion with ~~an~~ a recess for receiving an optical semiconductor component and an elongated linear groove for receiving an optical fiber. The optical fiber is positioned within the groove in ~~said~~ the substrate such that the top surface of the optical fiber is substantially at or below the upper surface of the substrate and the optical fiber is operatively aligned with the optical semiconductor component for the transfer of optical signals therebetween. A frame is hermetically sealed to the upper surface of the substrate.